DECLARATION AND POWER OF ATTORNEY

As a below named inventor, I hereby declare that: my residence, post office address and citizenship are as stated below next to my name; I believe I am the original, first, and sole inventor (if only one name is listed below) or an original, first, and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

IMPROVED PROCESS FOR PREPARING REBAMIPIDE

☐ is attached an ☐ was filed on ☒ was filed on N was amended	as United S Nov.30, 2005 as PCT Inte		√o. and/or .≅☑/JIP2005/022412 and
I hereby state that I have mended by any amendmer s defined in 37 CFR § 1.56	nt referred to above. I acknow	e contents of the above-io wledge the duty to disclos	dentified specification, including the claims, as se information which is material to patentability
nventor's certificate or § 365 states, listed below and hav	5(a) of any PCT international e also identified below, any faving a filing date before the	l application(s) designatin foreign application(s) for p	of any foreign application(s) for patent or ag at least one country other than the United patent or inventor's certificate, or any PCT which priority is claimed:
Country	Application Number	Date of Filing	Priority Claimed Under 35 U.S.C. 119
Japan	2004-348425	Dec. 1, 2004	YES □ NO
			YES NO
D			
I hereby claim the benefit	under 35 U.S.C. § 119(e) of	any United States provis	ional application(s) listed below:
	under 35 U.S.C. § 119(e) of ation Number	any United States provis	ional application(s) listed below: Date of Filing
		any United States provis	
Applica		any United States provis	
I hereby claim the benefit pplication(s) designating the pplication is not disclosed in aragraph of 35 U.S.C. § 11	under 35 U.S.C. § 120 of an e United States, listed below the prior United States or F 2, I acknowledge the duty to	y United States application and, insofar as the subject of the sub	
I hereby claim the benefit pplication(s) designating the pplication is not disclosed in aragraph of 35 U.S.C. § 11. FR § 1.56 which became a	under 35 U.S.C. § 120 of an e United States, listed below n the prior United States or F 2, I acknowledge the duty to evailable between the filing d	y United States application and, insofar as the subject of the sub	Date of Filing on(s) or § 365(c) of any PCT International ect matter of each of the claims of this tion(s) in the manner provided by the first ch is material to patentability as defined in 37
I hereby claim the benefit pplication(s) designating the pplication is not disclosed in aragraph of 35 U.S.C. § 11 FR § 1.56 which became a ate of this application:	under 35 U.S.C. § 120 of an e United States, listed below n the prior United States or F 2, I acknowledge the duty to evailable between the filing d	ny United States application and, insofar as the subject of the mational application which are of the prior application at the prior at the prior application at the prior	Date of Filing on(s) or § 365(c) of any PCT International ect matter of each of the claims of this tion(s) in the manner provided by the first ch is material to patentability as defined in 37 n(s) and the national or PCT International filing

I hereby appoint the following attorney and/or agent(s) to prosecute this application and transact all business in the Patent and Trademark Office connected therewith.

Finnegan, Henderson, Farabow, Garrett & Dunner, L.L.P., Customer Number 22,852.

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under section 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Page 1 of 3

[TITLE]

January 2000

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